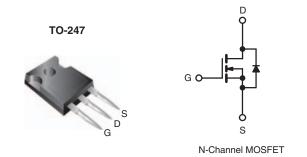


Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	600				
$R_{DS(on)}\left(\Omega\right)$	V _{GS} = 10 V	0.40			
Q _g (Max.) (nC)	210				
Q _{gs} (nC)	26				
Q _{gd} (nC)	110				
Configuration	Single				



FEATURES

- · Dynamic dV/dt Rating
- · Repetitive Avalanche Rated
- Isolated Central Mounting Hole
- · Fast Switching
- Ease of Paralleling
- · Simple Drive Requirements
- Lead (Pb)-free Available

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-247 package is preferred for commercial-industrial applications where higher power levels preclude the use of TO-220 devices. The TO-247 is similar but superior to the earlier TO-218 package because of its isolated mounting hole. It also provides greater creepage distance between pins to meet the requirements of most safety specifications.

ORDERING INFORMATION	
Package	TO-247
Lead (Pb)-free	IRFPC60PbF
Lead (Fb)-liee	SiHFPC60-E3
SnPb	IRFPC60
SHFD	SiHFPC60

ABSOLUTE MAXIMUM RATINGS T	_C = 25 °C, u	nless otherw	rise noted			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	600	V	
Gate-Source Voltage			V_{GS}	± 20	_ v	
Continuous Dunin Comment	V _{GS} at 10 V	T _C = 25 °C		16		
Continuous Drain Current		T _C = 100 °C	ID	10	Α	
Pulsed Drain Current ^a			I _{DM}	64		
Linear Derating Factor				2.2	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	1000	mJ	
Repetitive Avalanche Current ^a			I _{AR}	16	Α	
Repetitive Avalanche Energy ^a			E _{AR}	28	mJ	
Maximum Power Dissipation	T _C =	: 25 °C	P _D	280	W	
Peak Diode Recovery dV/dt ^c			dV/dt	3.0	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	00	
Soldering Recommendations (Peak Temperature)	for 10 s		-	300 ^d	°C	
Mounting Torque	6.00.0*1	0.00 140		10	lbf ⋅ in	
	6-32 or M3 screw			1.1	N · m	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 7.2 mH, R_G = 25 Ω , I_{AS} = 16 A (see fig. 12). c. $I_{SD} \le$ 16 A, $dI/dt \le$ 140 A/ μ s, $V_{DD} \le$ V_{DS} , V_{DS} = 150 °C.
- d. 1.6 mm from case.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply

IRFPC60, SiHFPC60

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	40		
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.24	-	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	0.45		

SPECIFICATIONS T _J = 25 °C, t	SYMBOL		MIN.	TYP.	MAX.	UNIT	
Static	STWIBOL	IES	T CONDITIONS	IVIIIV.	IIF.	WAA.	ONIT
	V	V	0.1/ 1 0504	600	I	l	Ιv
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V, } I_{D} = 250 \mu\text{A}$		600	830	-	-
V _{DS} Temperature Coefficient	ΔV _{DS} /T _J		e to 25 °C, I _D = 1 mA		630		mV/°C
Gate-Source Threshold Voltage	V _{GS(th)}	+	= V _{GS} , I _D = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 20 V		-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}		= 600 V, V _{GS} = 0 V V, V _{GS} = 0 V, T _J = 125 °C	-	-	100 500	μΑ
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 9.6 A ^b	-	-	0.40	Ω
Forward Transconductance	9 _{fs}	V _{DS} :	= 50 V, I _D = 9.6 A ^b	13	-	-	S
Dynamic							
Input Capacitance	C _{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ $f = 1.0 \text{ MHz}, \text{ see fig. } 5$		-	3900	-	
Output Capacitance	C _{oss}			-	440	-	pF
Reverse Transfer Capacitance	C _{rss}			-	98	-	1 .
Total Gate Charge	Qg	V _{GS} = 10 V	I _D = 16 A, V _{DS} = 360 V, see fig. 6 and 13 ^b	-	-	210	nC
Gate-Source Charge	Q _{gs}			-	-	26	
Gate-Drain Charge	Q _{gd}			-	-	110	
Turn-On Delay Time	t _{d(on)}			-	19	-	
Rise Time	t _r	$V_{DD} = 300 \text{ V}, I_{D} = 16 \text{ A},$ $R_{G} = 4.5 \Omega, R_{D} = 18 \Omega$ see fig. 10 ^b		-	54	-	ns
Turn-Off Delay Time	t _{d(off)}			-	110	-	
Fall Time	t _f			-	56	-	
Internal Drain Inductance	L_D	Between lead, 6 mm (0.25") from package and center of die contact		-	5.0	-	- nH
Internal Source Inductance	L _S			-	13	-	
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	16	
Pulsed Diode Forward Current ^a	I _{SM}			-	-	64	Α
Body Diode Voltage	V _{SD}	T _J = 25 °C, I _S = 16 A, V _{GS} = 0 V ^b		-	-	1.8	V
Body Diode Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = 16 A, dl/dt = 100 A/ μ s ^b		-	610	920	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	6.6	9.9	μC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L_S and L_Γ				[D)	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. Pulse width \leq 300 μ s; duty cycle \leq 2 %.



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

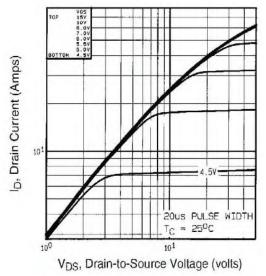


Fig. 1 - Typical Output Characteristics, T_C = 25 $^{\circ}C$

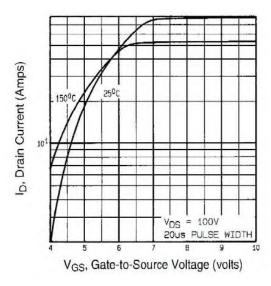


Fig. 3 - Typical Transfer Characteristics

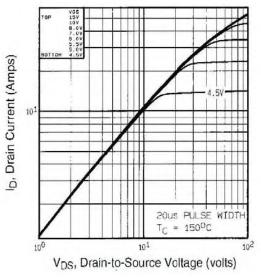


Fig. 2 - Typical Output Characteristics, $T_C = 150$ °C

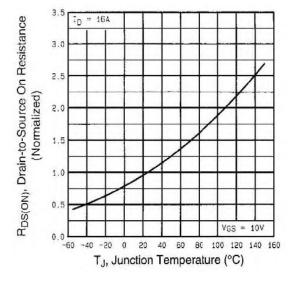


Fig. 4 - Normalized On-Resistance vs. Temperature

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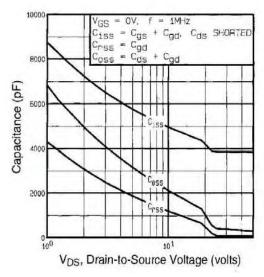


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

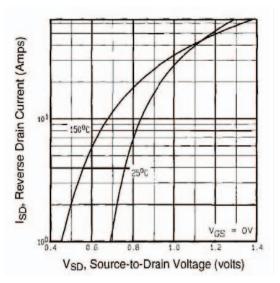


Fig. 7 - Typical Source-Drain Diode Forward Voltage

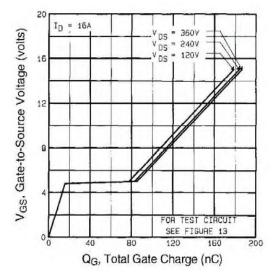


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

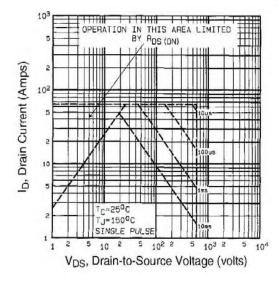


Fig. 8 - Maximum Safe Operating Area





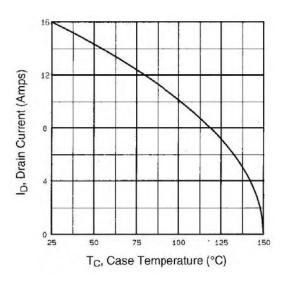


Fig. 9 - Maximum Drain Current vs. Case Temperature

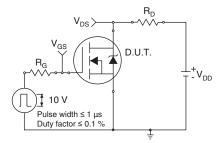


Fig. 10a - Switching Time Test Circuit

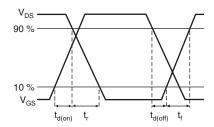


Fig. 10b - Switching Time Waveforms

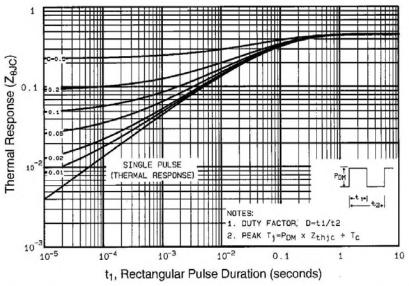


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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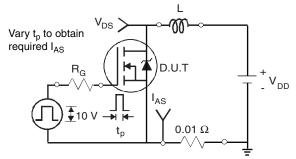


Fig. 12a - Unclamped Inductive Test Circuit

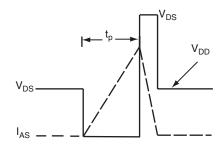


Fig. 12b - Unclamped Inductive Waveforms

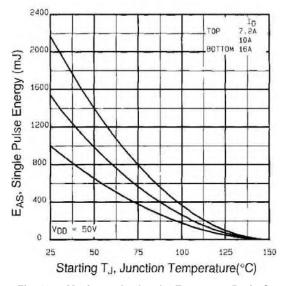


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

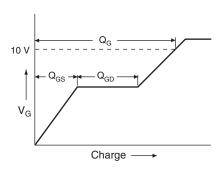


Fig. 13a - Basic Gate Charge Waveform

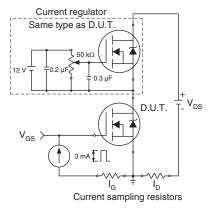
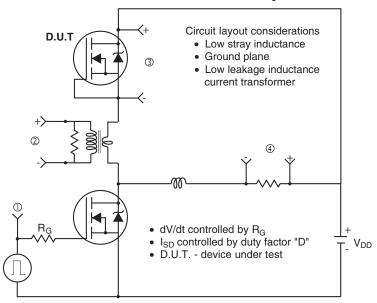
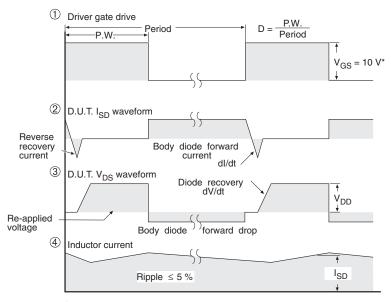


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit





* V_{GS} = 5 V for logic level and 3 V drive devices

Fig. 14 - For N-Channel

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